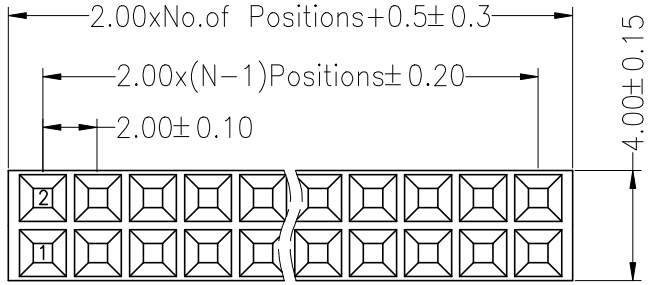
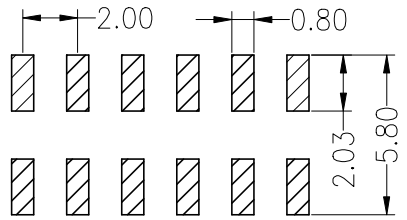
HSF RoHS FILE NO :E362810

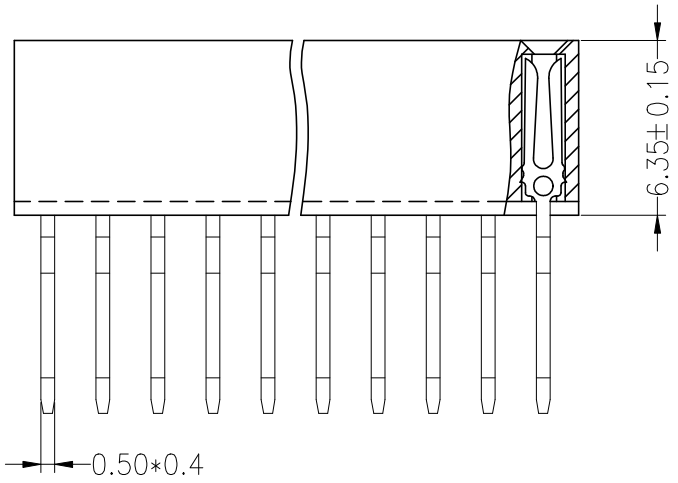
SPECIFICATIONS
Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

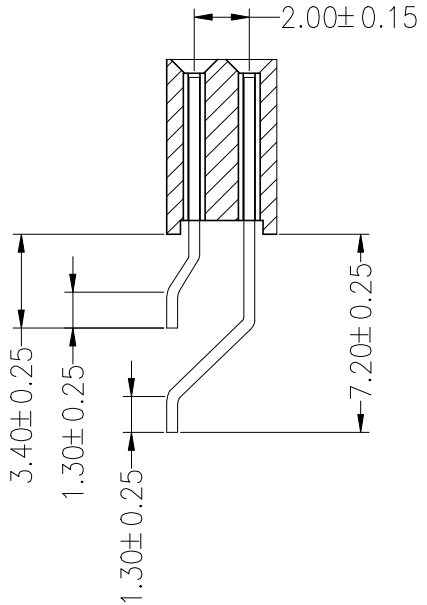
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)







Ordering Information

2363 02 XX X N XX Z Y X 0X

- XX — No.of Pins Per Row 2~40
- X — Insulator Material Option: C=BK−PA6T, E=BK−PA9T, F=BK−LCP
- XX — Contact Plating: G1:Gold Flash, G2:1.5U" Gold, G3:2U" Gold, G4:3U" Gold, G5:5U" Gold, G6:10U" Gold, G7:15U" Gold, S0:Gold Flash/Tin, SN:Tin
- X — Packing: 0=PE Bag, A=Tray, T=Tube, R=Reel

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.04.18	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.04.18	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	236302XXXNXXZYX0X
TITLE:	2.00PF H6.35mm 2xNpin 90° SMT